

Nch 250V 8A Power MOSFET

V_{DSS}	250V
R _{DS(on)} (Max.)	300mΩ
I _D	±8A
P _D	85W

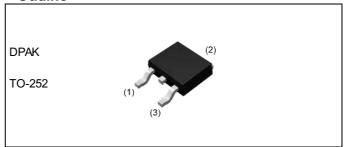
●Features

- 1) Low on-resistance
- 2) Fast switching
- 3) Drive circuits can be simple
- 4) Parallel use is easy
- 5) Pb-free plating; RoHS compliant

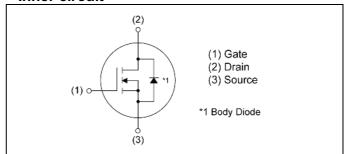
Application

Switching application

Outline



•Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	16
	Basic ordering unit (pcs)	2500
	Taping code	TL1
	Marking	RD3U080CN

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

	u ,	'		
Parameter	Symbol	Value	Unit	
Drain - Source voltage	V_{DSS}	250	V	
O-ations during some at	T _c = 25°C	I _D *1	±8	Α
Continuous drain current	T _c = 100°C	I _D *1	±4.2	Α
Pulsed drain current		I _{DP} *2	32	Α
Gate - Source voltage		V _{GSS}	±30	V
Avalanche energy, single pulse		E _{AS} *3	4.67	mJ
Avalanche current, single pulse		I _{AS} *3	4	Α
Power dissipation (T _c = 25°C)		P _D	85	W
Junction temperature		T _j	150	°C
Operating junction and storage temperature range		T _{stg}	-55 to +150	°C

●Thermal resistance

Doromotor	Symbol	Values			I limit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	1.46	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

● Electrical characteristics (T_a = 25°C)

Davameter	Cymah al	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 1mA$	250	-	-	V	
Zero gate voltage	1	V _{DS} = 250V, V _{GS} = 0V					
drain current	I _{DSS}	$T_j = 25^{\circ}C$	-	-	10	μA	
Gate - Source leakage current I _{GSS}		$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	±100	nA	
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	3.0	1	5.0	٧	
Static drain - source on - state resistance	R _{DS(on)} *4	V _{GS} = 10V, I _D = 4A	-	225	300	mΩ	
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = 10V, I _D = 4A	2.7	-	-	S	

^{*1} Limited only by maximum temperature allowed.

^{*2} Pw \leq 10µs, Duty cycle \leq 1%

^{*3} L \simeq 500 μ H, V_{DD} = 50V, R_G = 25 Ω , starting T $_j$ = 25°C

^{*4} Pulsed

● Electrical characteristics (T_a = 25°C)

Darameter	Cymah al	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	1440	-		
Output capacitance	C _{oss}	V _{DS} = 25V	-	80	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	40	1		
Turn - on delay time	$t_{d(on)}^{*4}$	$V_{DD} \simeq 125V$, $V_{GS} = 10V$	-	30	1		
Rise time	t _r *4	I _D = 4A	-	40	1	no	
Turn - off delay time	t _{d(off)} *4	$R_L \simeq 31.25\Omega$	-	40	1	ns	
Fall time	t _f *4	$R_G = 10\Omega$	-	15	-		

● Gate charge characteristics (T_a = 25°C)

Darameter	Symbol Conditions		Values			Lloit
Parameter	Symbol	Symbol Conditions —		Тур.	Max.	Unit
Total gate charge	Q_g^{*4}	V _{DD} ≃ 125V	-	25	-	
Gate - Source charge	Q _{gs} *4	I _D = 8A	-	10	-	nC
Gate - Drain charge	Q _{gd} *4	V _{GS} = 10V	-	10	-	
Gate plateau voltage	V _(plateau)	V _{DD} ≈ 125V, I _D = 8A	-	6.5	-	V

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Continuous forward current	I _S *1	T = 25°C	-	-	8	Α	
Pulse forward current	I _{SP} *2	T _C = 25°C	1	1	32	Α	
Forward voltage	V _{SD} *4	$V_{GS} = 0V, I_{S} = 8A$	ı	ı	1.5	V	
Reverse recovery time	t _{rr} *4	I _S = 4A	ı	100	1	ns	
Reverse recovery charge	Q _{rr} *4	di/dt = 100A/μs	-	365	ı	nC	

Fig.1 Power Dissipation Derating Curve

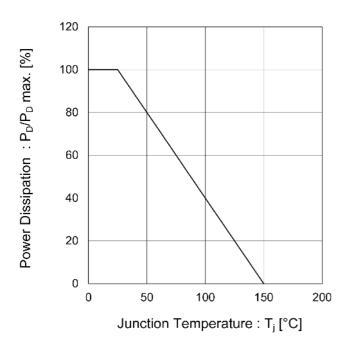


Fig.2 Maximum Safe Operating Area

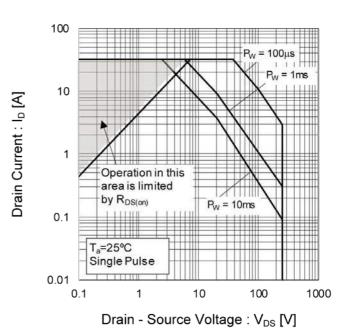
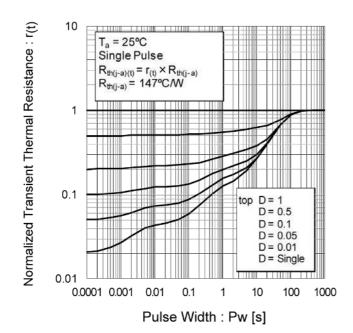


Fig.3 Transient ThermalResistance vs. Pulse Width



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Fig.4 Avalanche Current vs. Inductive Load

Fig.5 Avalanche Energy Derating Curve vs. Junction Temperature

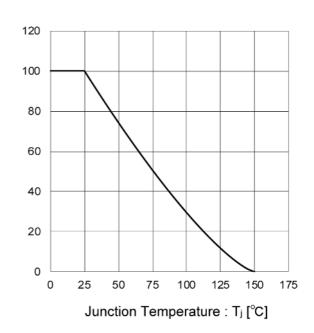
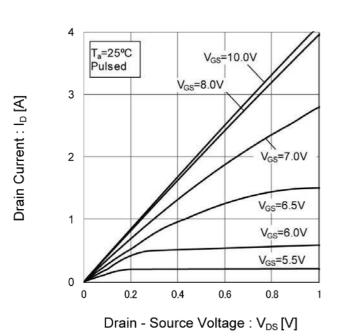


Fig.6 Typical Output Characteristics(I)



Drain Current : I_D [A]

Avalanche Energy : E_{AS} / E_{AS} max_. [%]

8 T_a=25℃ V_{GS}=10.0V Pulsed V_{GS}=8.0V 6 $V_{GS}=7.0V$ 4 V_{GS}=6.5V 2 V_{GS}=6.0V V_{GS}=5.5V 0 2 6 10

Drain - Source Voltage: V_{DS}[V]

Fig.7 Typical Output Characteristics(II)

Fig.8 Breakdown Voltage vs. Junction Temperature

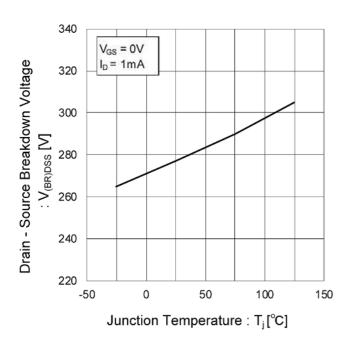


Fig.9 Typical Transfer Characteristics

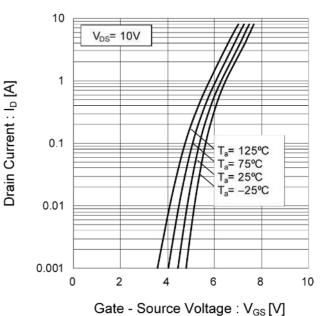


Fig.10 Gate Threshold Voltage vs. Junction Temperature

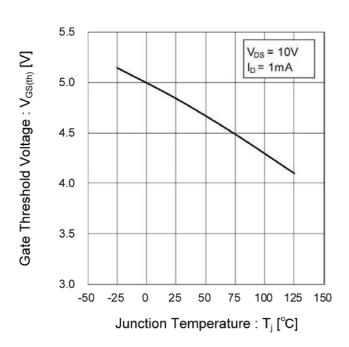
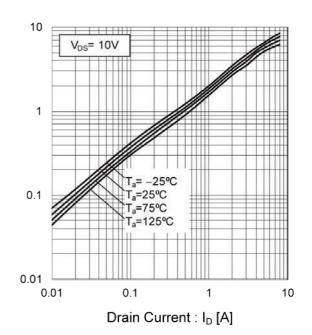


Fig.11 Transconductance vs. Drain Current



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Transconductance : gfs [S]

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

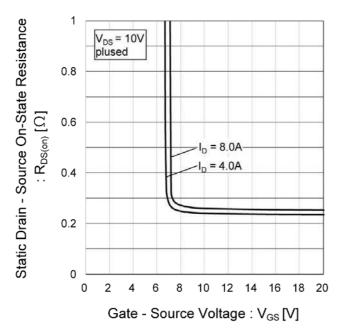


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current(I)

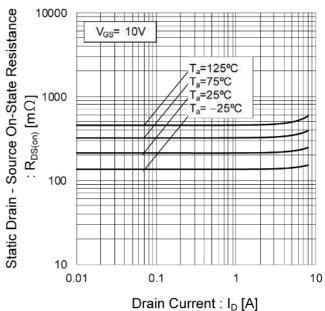


Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature

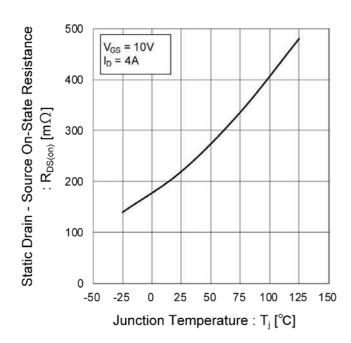


Fig.15 Typical Capacitance vs. Drain - Source Voltage

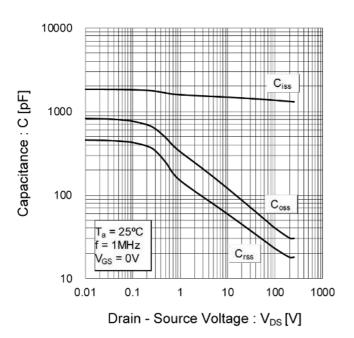


Fig.16 Switching Characteristics

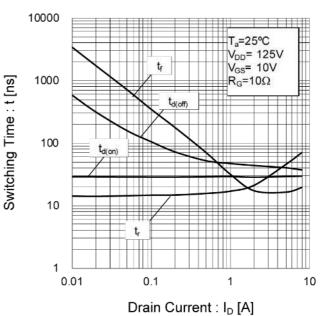
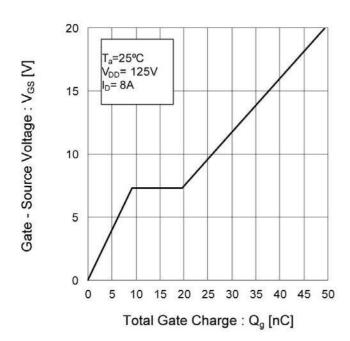


Fig.17 Dynamic Input Characteristics



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Fig.18 Source Current vs. Source-Drain Voltage

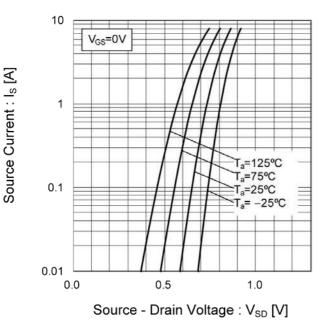
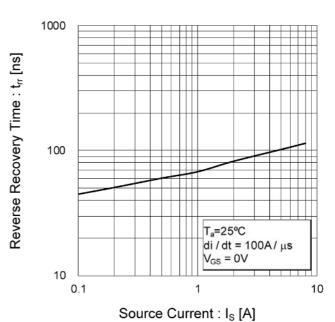


Fig.19 Source Current vs. Reverse Recovery Time



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Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

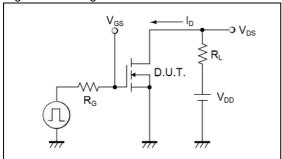


Fig.2-1 Gate Charge Measurement Circuit

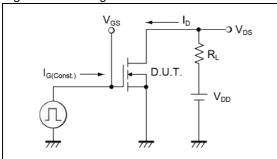


Fig.3-1 Avalanche Measurement Circuit

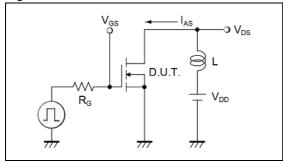


Fig.1-2 Switching Waveforms

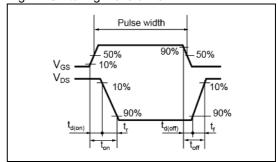


Fig.2-2 Gate Charge Waveform

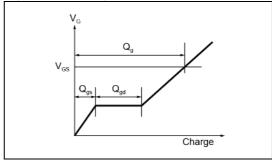
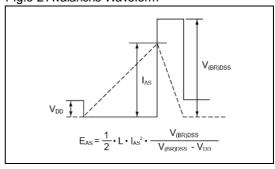
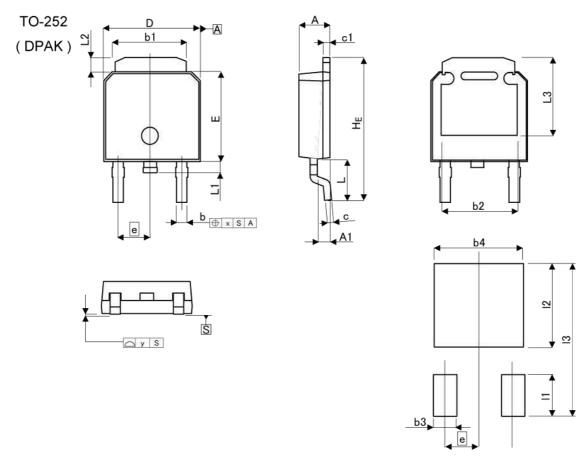


Fig.3-2 Avalanche Waveform



Dimensions



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM -	MILIME	ETERS	INC	HES
DIIVI	MIN	MAX	MIN	MAX
Α	2.20	2.40	0.087	0.094
A1	0.70	1.10	0.028	0.043
b	0.60	0.90	0.024	0.035
b1	5.20	5.50	0.205	0.217
b2	5.	35	0.2	211
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	30	0.091	
E	6.00	6.40	0.236	0.252
HE	9.40	10.40	0.370	0.409
L	2.	70	0.1	06
L1	0.60	1.00	0.024	0.039
L2	0.70	1.30	0.028	0.051
L3	5.	30	0.2	209
х	24	0.25	а	0.010
у	:7.1	0.10	=	0.004

DIM	MILIME	MILIMETERS		HES
DIIVI	MIN	MAX	MIN	MAX
b3	12.1	1.15	9	0.045
b4	-	5.55	8	0.219
11	12	2.77	2	0.109
12		5.50	-	0.217
13	2	10.40	2	0.409

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	ОГАССШ	CLASS II b	CLASSIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSIII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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